

159 Series Telelink® Fuse and Clip Assembly




Description

The 159 Series product is a metal fuse clip with pre-installed Littelfuse 461 Series TeleLink® fuse. This fuse and clip combination can be automatically installed in PC Boards in one efficient manufacturing operation. It permits quick and easy fuse replacement without exposing the PC Board and other components to risks of rework solder heat as required with direct surface mount fuses.

It meets UL 60950 power cross requirements and is designed to allow compliance with Telcordia GR-1089-CORE and TIA-968-A Surge Specifications. The product provides coordinated protection with Littelfuse SIDACTor® protection thyristors without series resistors.

Agency Approvals

AGENCY	AGENCY FILE NUMBER	AMPERE RANGE
	E14721	0.5A, 1.25A, 2.0A

Electrical Characteristics for Series

% of Ampere Rating	Opening Time
100%	4 hours, Minimum
250%	1 sec., Minimum 120 secs., Maximum

Additional Information



Datasheet



Resources



Samples


Features

- Offer low profile easily-replaceable fuse alternative compatible with automated PCB surface mount equipment
- Come supplied with surge resistant Littelfuse 461 series TeleLink® Slo-Blo® fuse
- Fuse designed to allow compliance with Telcordia GR-1089-CORE and TIA-968-A (formerly FCC Part 68) Surge Specifications
- Provide coordinated protection with Littelfuse SIDACTor® protection thyristor devices and GDTs, without series resistors
- RoHS compliant and Halogen Free
- Clip fully compatible with RoHS/lead-free solder alloys and higher temperature profiles associated with lead-free assembly
- Available in ratings of 0.5-2.0 Amperes

Applications

- Telecom equipment (POTS) applications such as modems, answering machines, telephones, fax machines, and security systems
- Network equipment, such as:
 - SLIC interface portion of Fiber to the Curb (FTTC) and Fiber to the Premises (FTTP)
 - Non-Fiber SLIC interface for Central Office (CO) locations and Remote Terminals (RT)
 - xDSL applications such as ADSL, ADSL2+, VDSL, and VDSL2+
 - Ethernet 10/100/1000BaseT
 - ISDN "U" interface
 - Baystation T1/E1/J1, T3 (DS3) trunk cards

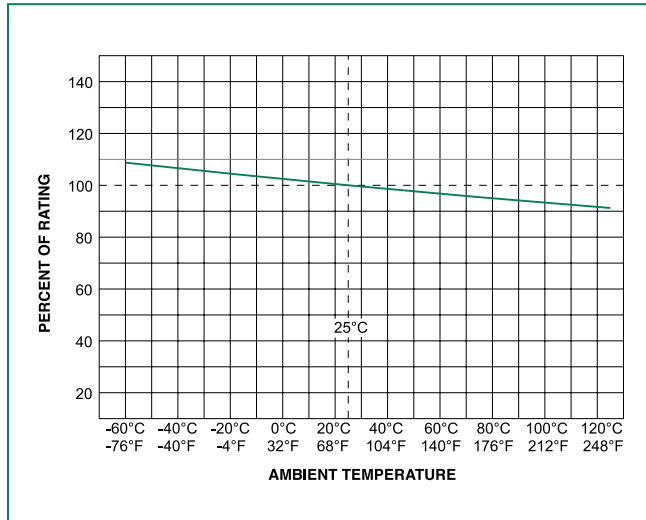
Electrical Specifications by Item

Ampere Rating (A)	Amp Code	Max Voltage Rating (V)	Interrupting Rating	Nominal Cold Resistance (Ohms)	Nominal Melting I ² t (A ² sec)	Agency Approvals
						
0.50	.500	600	60 A @600 VAC	0.560	0.840 ¹	x
1.25	1.25	600		.1040	16.5 ¹	x
2.00	002.	600		.0450	17.5 ¹	x

¹ I²t is calculated at 10 msec. or less. I²t at 10 times rated current has a typical value of: 24 A²sec (2.0A), 22 A²sec (1.25A), 1.3 A²sec (0.5A).

- Typical inductance < 40nH up to 500 MHz.
- Resistance changes 0.5% for every °C.
- Resistance is measured at 10% rated current.

Temperature Re-rating Curve



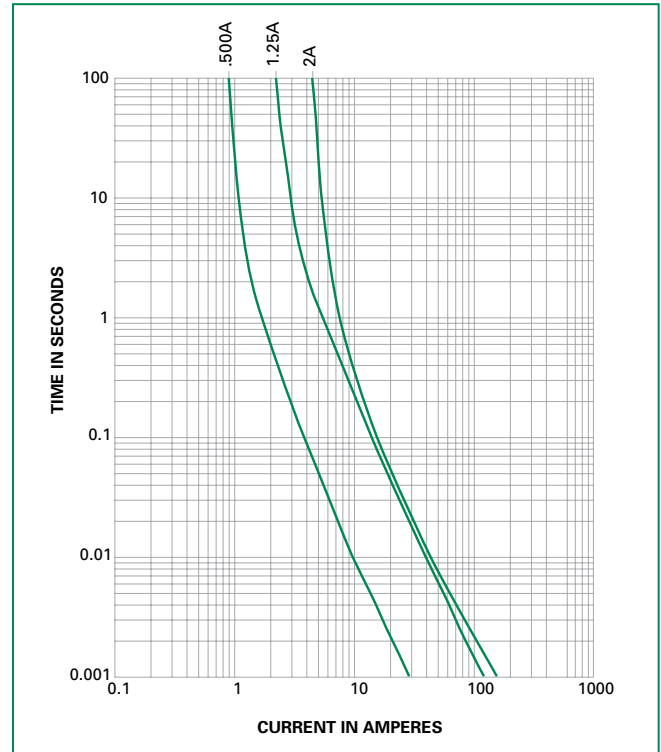
Note:

1. Re-rating depicted in this curve is in addition to the standard re-rating of 25% for continuous operation.

Maximum Temperature Rise

Telecom Nano ² ® Fuse	Temperature
04611.25	≤82°C (180°F)
0461002	≤50°C (122°F)

Average Time Current Curves



TIA-968-A (formerly FCC part 68) Surge Waveforms

(fuse can not open during type B events)

Surge	Voltage (V)	Waveform (μs)	Current (A)	Repetitions	Recommended Fuse
Metallic A	800	10×560	100	1 ea. polarity	1.25
Longitudinal A	1500	10×160	200	1 ea. polarity	1.25
Metallic B	1000	9×720	25	1 ea. polarity	1.25
Longitudinal B	1500	9×720	37.5	1 ea. polarity	1.25

For the type A events the 0.5 fuse will open, providing non-operational compliance. The 1.25 & 2.0 will not open, providing for operational compliance with TIA-968-A type A surge events.

GR 1089 Inter-building requirements

GR 1089 1st level lightning surge inter-building

(Equipment under test can not be damaged and must continue to operate properly)

Surge	Minimum Peak Voltage (V)	Minimum Peak Current (A)	Max. Rise/Min. Decay (µs)	Repetitions Each Polarity	Fuse Choices
1	600	100	10/1000	25	1.25, 2.0
2	1000	100	10/360	25	1.25, 2.0
3	1000	100	10/1000	25	1.25, 2.0
4	2500	500	2/10	10	1.25, 2.0
5	1000	25	10/360	5	0.5, 1.25, 2.0

If sufficient series resistance is used, then the 0.5 fuse may be used in test conditions 1-4.

GR 1089 AC power fault 1st level inter-building (fuse not allowed to open)

Test	Vrms	Short Circuit Current (A)	Hits	Duration	Primary Protector	Fuse Choices
1	50	.33	1	15 min.	removed	1.25, 2.0
2	100	.17	1	15 min.	removed	1.25, 2.0
3	200,400, 600	1	60	1 sec.	removed	1.25, 2.0
4	1000	1	60	1 sec.	operative	1.25, 2.0
5	Diagram	Diagram	60	5 secs.	removed	1.25, 2.0
6	600	0.5	1	30 secs.	removed	1.25, 2.0
7	440	2.2	5	2 secs.	removed	1.25, 2.0
8	600	3	1	1.1 secs.	removed	1.25, 2.0
9	1000	5	1	0.4 sec.	in place	1.25, 2.0

GR 1089 2nd level lightning surge telecom port

(Equipment under test shall not become a fire, fragmentation, or electrical safety hazard)

Surge	Minimum Peak Voltage (V)	Minimum Peak Current (A)	Max. Rise/Min. Decay (µs)	Repetitions Each Polarity	Fuse Choices
1	5000	500	2/10	1	0.5, 1.25, 2.0
Alternative	5000	500/8=625	8/10	1	0.5, 1.25, 2.0

The 0.5 fuse will open during these test conditions. The 1.25 & 2.0 will not open thus providing operational compliance.

GR 1089 AC power fault 2nd level (fuse can open but must open in a safe and controlled manner)

Test Circuite	Vrms	Short (A)	Duration	Fuse
1	120,277	25	15 min.	0.5, 1.25, 2.0
2	600	60	5 secs.	0.5, 1.25, 2.0
3	600	7	5 secs.	0.5, 1.25, 2.0
4	100-600	2.2	15 min..	0.5, 1.25, 2.0
5	Diagram	Diagram	15 min.	0.5, 1.25, 2.0

Fuse must open before wiring simulator fuse (MDL 2.0).

UL60950 Requirements

UL 60950 (EN 60950, formerly UL 1950) Power Cross Test (L=Longitudinal, M=Metallic)

Test Number	Voltage (V)	Current (A)	Time	Fuse Choices
L1	600	40	1.5 secs.	0.5, 1.25, 2.0
L2	600	7	5 secs.	0.5, 1.25, 2.0
L3	600	2.2	30 min.	0.5, 1.25, 2.0
L4	200	2.2	30 min.	0.5, 1.25, 2.0
L5	120	25	30 min.	0.5, 1.25, 2.0
M1	600	40	1.5 secs.	0.5, 1.25, 2.0
M2	600	7	5 secs.	0.5, 1.25, 2.0
M3	600	2.2	30 min.	0.5, 1.25, 2.0
M4	600	2.2	30 min.	0.5, 1.25, 2.0

Selection of test number depends on current limiting F fire enclosure/spacing of end product

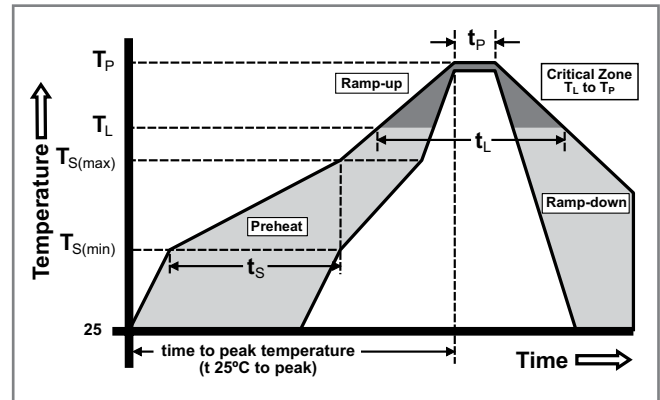
- 26 AWG line cord removes L1/M1 test requirement
 - L5 conducted only if product does not pass section 6.1.2
 - L2,M2,L3,M3,L4,M4 conducted if not in a fire enclosure
- Fuse must open before the wiring simulator fuse (MDL 2.0).

UL 60950 (EN 60950, formerly UL 1950) Impulse Test and Steady-State Electric Strength Test

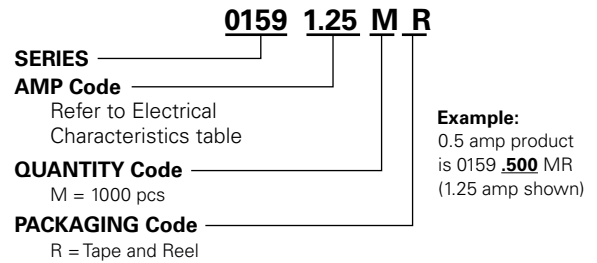
Test	Voltage (V)	Current (A)	Waveform	Repetitions	Fuse Choices
Impulse					
For handheld units	2500	62.5	10x700ms	+ 10 w/60 secs. rest	0.5, 1.25, 2.0
Non handheld	1500	37.5	10x700ms	+ 10 w/60 secs. rest	0.5, 1.25, 2.0
Steady-State					
For handheld units	1500		60Hz		0.5, 1.25, 2.0
Non handheld	1000		60Hz		0.5, 1.25, 2.0

Soldering Parameters

Reflow Condition		Pb – free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (Min to Max) (t_s)	60 – 120 seconds
Average Ramp-up Rate (LiquidusTemp (T_L) to peak)		3°C/second max.
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max.
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 90 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		20 – 40 seconds
Ramp-down Rate		6°C/second max.
Time 25°C to peak Temperature (T_p)		8 minutes max.
Do not exceed		260°C



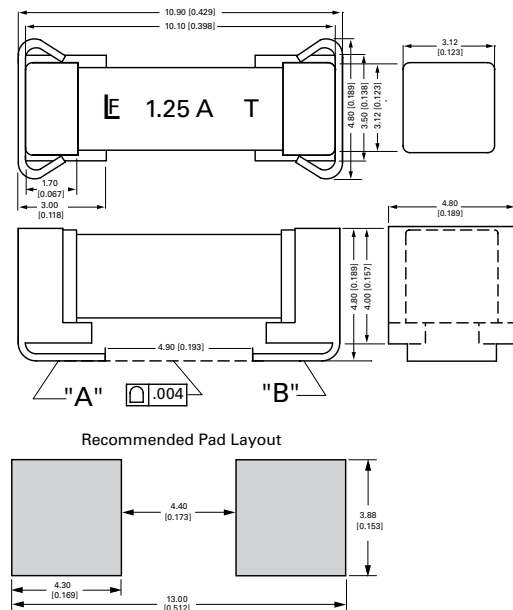
Part Numbering System



Product Characteristics

Materials	Fuse Body: Ceramic Fuse Caps/Terminals: Silver-plated Brass Clip Base: Gold-plated Clip Terminals: Nickel-plated
Product Marking	Brand Logo, Current Rating, 'T'
Insulation Resistance (after opening)	MIL-STD-202, Method 302, Test condition A (10,000 ohms, minimum)
Operating Temperature	-55°C to 125°C with proper re-rating
Humidity Test	85°C/ 85% RH, 1000 hours
Solderability	MIL-STD-202, Method 208/IPC EIA J-STD-002, Test Condition A
Resistance to Solvents	MIL-STD-202, Method 215 (3 solvent types)
Thermal Shock	MIL-STD-202, Method 107, Test Condition B3 (95 cycles -65°C to +125°C)
Mechanical Shock	MIL-STD-202, Method 213, Test Condition I (100G's peak for 6 msecs.)
Vibration	MIL-STD-202, Method 201, (10-55 Hz)
Moisture Resistance	MIL-STD-202, Method 106, High Humidity (90-98% RH), Heat (65°C)
Salt Spray/ Atmosphere	MIL-STD-202, Method 101, Test Condition B (48 hours)
Terminal Attachment	MIL-STD-202, Method 211, Test Condition A, 5 lbs applied to end caps

Dimensions



Packaging

Packaging Option	Packaging Specification	Quantity	Quantity & Packaging Code
24mm Tape and Reel	EIA RS-481-2 (IEC 286, part 3)	1000	MR

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9